



Digital Systems Modeling and Synthesis

Digitaalsüsteemide modelleerimine ja süntees

IAY0340 – 5.0 EAP 4 2-2-0 E S

<http://www.ati.ttu.ee/IAY0340/>

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Course plan

- Introduction and simulation principles [1 h]
- Hardware description language VHDL [7 h]
- VHDL and RTL synthesis [2 h]
- Testbenches, co-simulation and co-modeling of digital systems [4 h]
- Hardware description language SystemVerilog [4 h]
- Synthesis of digital systems at various abstraction levels [4 h]
- Hardware description language SystemC [2 h]
- Simulation of analog and digital systems – Spice, VHDL-AMS, etc. [2 h]
- Code transformations and system level description languages [2 h]

- Hands-on exercises [15*2 h]
 - Digital simulation and synthesis – various modules in VHDL [14 h]
 - Elevator model – VHDL & Verilog [4 h]
 - PicoCPU – simple processor [6 h]
 - FIR filter design, SystemC and analog simulation [6 h]



Textbooks

- Dirk Jansen et al. (editors), "The electronic design automation handbook." [2003]
- Peter J. Ashenden, "The Designer's Guide to VHDL." [2008]
- Volnei A. Pedroni, "Circuit Design with VHDL." [2004]
- Stuart Sutherland, Simon Davidman, Peter Flake, "System Verilog for Design." [2010]
- Michael John Sebastian Smith, "Application-Specific Integrated Circuits." [1997]
 - <http://www10.edacafe.com/book/ASIC/ASICs.php>
- David C. Black, Jack Donovan, "SystemC: From the Ground Up." [2004]

- **Plus some good older ones**
 - Kalle Tammemäe, "Riistvara kirjeldamiseks VHDL." [2002]
 - K.C. Chang, "Digital systems design with VHDL and synthesis: an integrated approach." [1999]
 - Ken Coffman, "Real world FPGA design with Verilog." [2000]

- **Plus web-based source, incl. Wikipedia**
 - Bryan Mealy, Fabrizio Tappero, "Free Range VHDL." [2012] – <http://freerangefactory.org>



Motivation

- **System-on-Chip (SoC) requires new design methodologies**
 - to increase designers productivity
 - to get products faster into market

- **There exists a demand for efficient design methodologies at higher abstraction levels**

- **A different thinking needed from the designers**

- **At higher abstraction levels**
 - a designer has much wider selection of possible decisions
 - each of these decisions has also a stronger impact onto the quality of the final design



Optimizations

- **Optimizations at logic level**
 - thousands of nodes (gates) can exist
 - only few possible ways exist how to map an abstract gate onto physical gate from target library
 - optimization algorithms can take into account only few of the neighbors
- **Optimizations at register transfer level (RTL)**
 - hundreds of nodes exist (adders, registers, etc.)
 - there are tens of possibilities how to implement a single module
- **At higher levels, e.g. at system level**
 - there are only tens of nodes to handle (to optimize)
 - there may exist hundreds of ways how to implement a single node
 - every possible decision affects much stronger the constraints put onto neighboring nodes thus significantly affecting the quality of the whole design



Decisions at higher abstraction levels

- **Two major groups of decisions**
 - **selection of the right algorithm to solve a subtask**
 - making transformations inside the algorithm, e.g. parallel versus sequential execution
 - affect primarily the final architecture of the chip
 - **decisions about the data representation**
 - e.g. floating point versus fixed point arithmetic, bit-width, precision.
- **Selection of a certain algorithm puts additional constraints also onto the data representation**
- **Selecting a data representation narrows also the number of algorithms available**



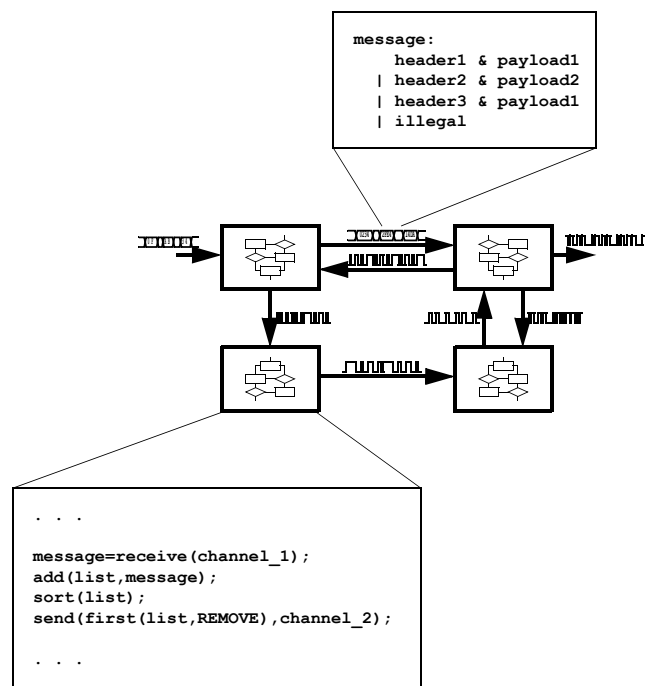
Design steps

- **System design**
a.k.a. Architectural-level synthesis
a.k.a. High-level synthesis
a.k.a. Structural synthesis
- description / specification → block diagram
- determining the macroscopic structure, *i.e.*, interconnection of the main modules (blocks) and their functionality
- **Logic design**
 - block diagram → logic gates
 - determining the microscopic structure, *i.e.*, interconnection of logic gates
- **Physical design**
a.k.a. Geometrical-level synthesis
 - logic gates → transistors, wires



Abstraction levels

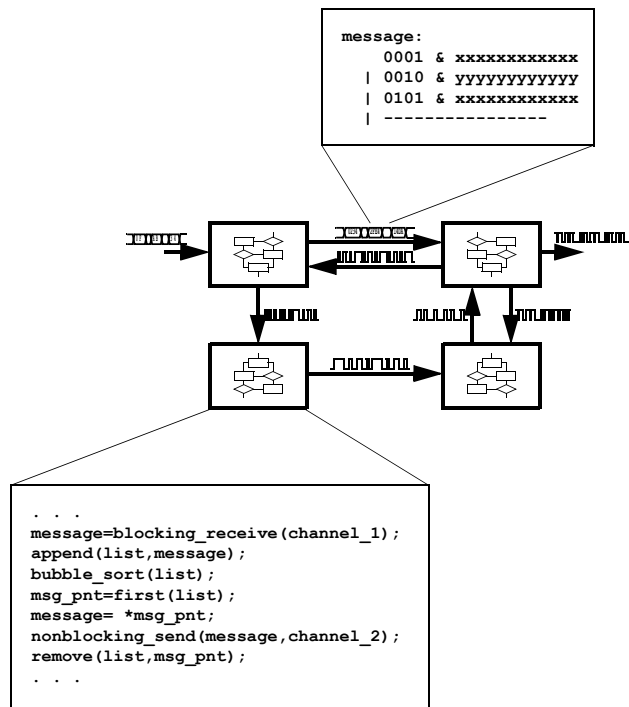
- **System level**
 - modules / methods
 - channels / protocols
- **System Level Synthesis**
 - Clustering.
 - Communication synthesis.



Abstraction levels

- **Algorithmic level**
 - (sub)modules / algorithms
 - buses / protocols

- **High-Level Synthesis**
 - Resource or time constrained scheduling.
 - Resource allocation. Binding.



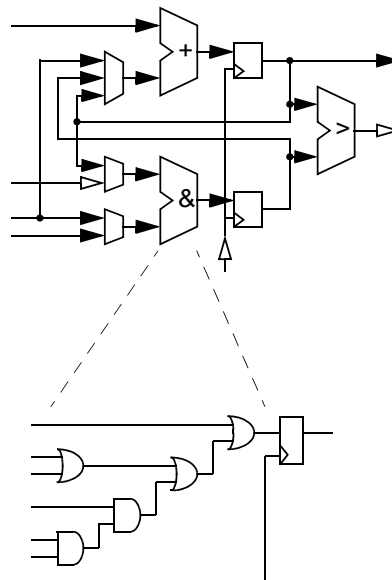
Abstraction levels

- **Register transfer (RT) level**
 - blocks / logic expressions
 - buses / words

- **Level Synthesis**
 - Data-path synthesis. Controller synthesis.

- **Logic level**
 - logic gates / logic expressions
 - nets / bits

- **Logic Level Synthesis**
 - Logic minimization. Optimization, overhead removal.

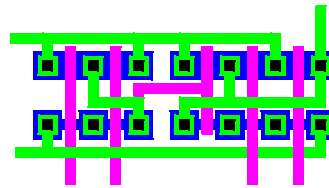
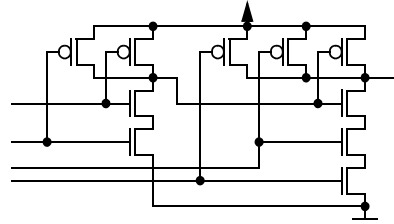




Abstraction levels

- **Physical level**
 - transistors / wires
 - polygons

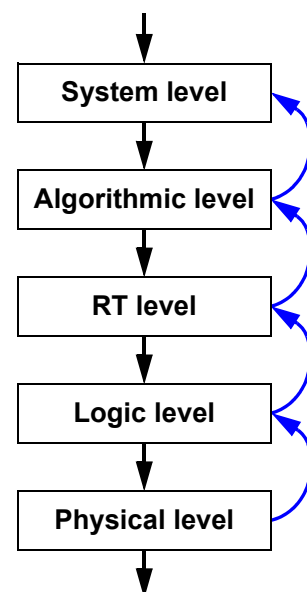
- **Physical Level Synthesis**
 - Library mapping.
 - Placement. Routing.



Design flow

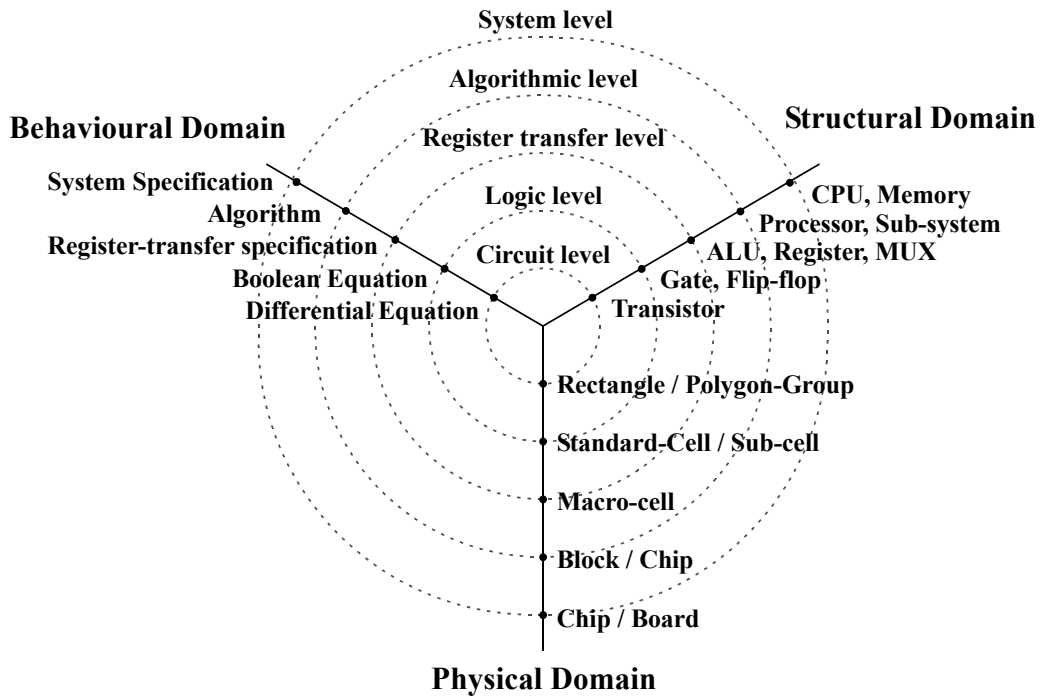
- **Specification refinement**
 - from higher to lower abstraction levels
 - refinement = transformations
- **Algorithm selection**
 - universal vs. specific
 - speed vs. memory consumption
- **Partitioning**
 - introducing structure
 - implementation environment -- HW vs. SW
- **Technology mapping**
 - converting algorithm into Boolean equations
 - replacing Boolean equations with gates

HW design flow

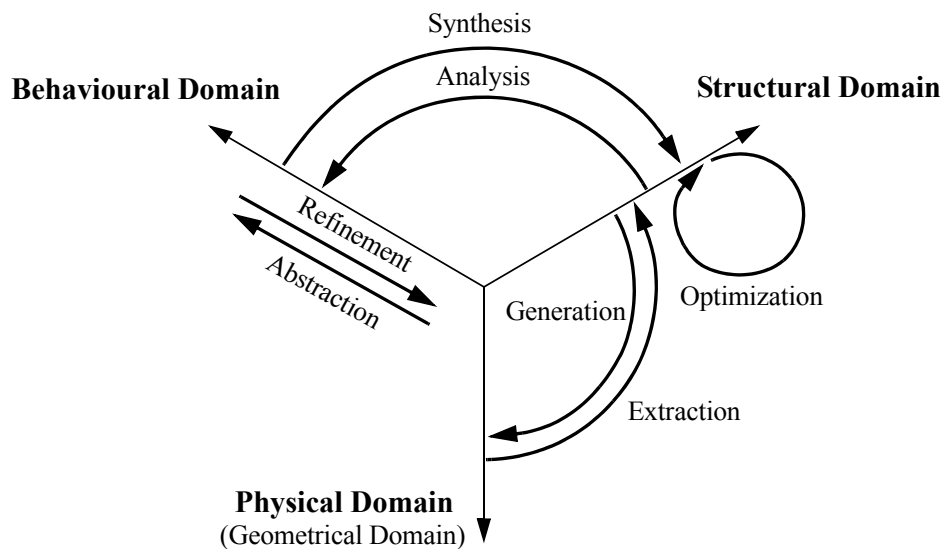




Y-chart

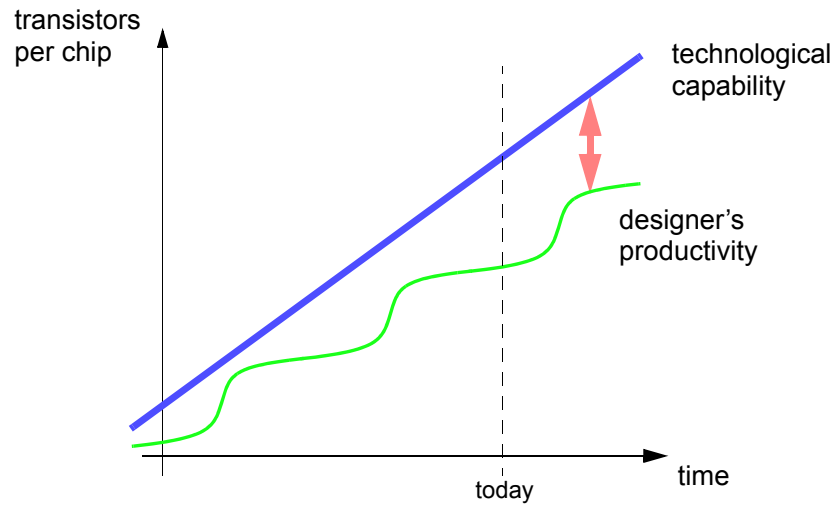


Y-transformations





Synthesis – design automation



Design automation – a bit idealistic view

- 1990 – 4 K gates / year / designer
- 1993 – inhouse place and route – 5.6K
- 1995 – engineer (RTL→GDSII) – 9.1K
- 1997 – small blocks reuse (2.5K-75K) – 40K
- 1999 – large blocks reuse (75K-1M) – 56K
- 2001 – synthesis (RTL→GDSII) – 91K
- 2003 – intelligent testbench – 125K
- 2005 – behavioral and architectural levels, HW/SW (co)design – 200K
- 2007 – very large blocks reuse (>1M, IP cores) – 600K
- 2009 – homogeneous parallel processing (multi-core) – 1200K
- *Future – hw/sw co-verification, executable specification, etc.*



Market = \$\$\$

- **Design cost**
 - *design time & chips production cost*
 - *huge investments (G\$)*
 - *almost impossible to correct*
- **High cost of modifications**
 - *large production volumes are more cost effective*
 - *zero-defect is very important*
 - *following market trends is important*
- **Price is inversely proportional to production volume**
 - *common purpose processors - cheap but not always usable*
 - *ASIC - application specific tuning (e.g. telecommunication)*
 - *prototypes - flexibility is extremely important in the development phase*
 - *special purpose chips (e.g. satellites)*
- **Reconfigurability**
 - *flexible products, possibility to modify working circuits*

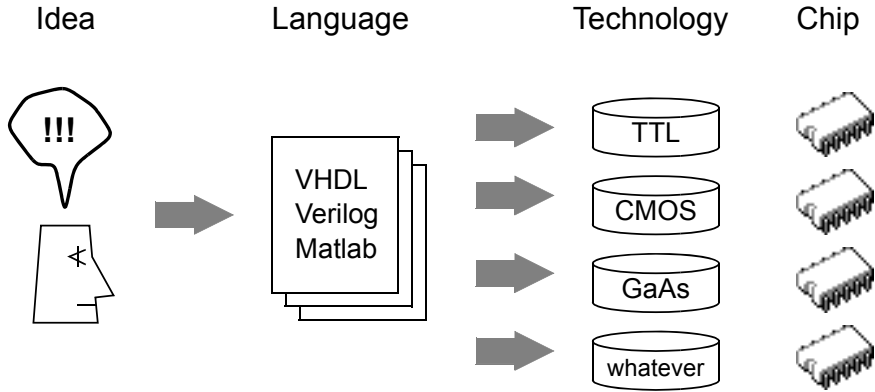


Design criteria

- **Three dimensions - area, delay, power**
 - *size, speed, energy consumption*
 - *four dimensions - plus testability (reliability)*
- **Area**
 - *gates, wires, buses, etc.*
- **Delay**
 - *inside a module, between modules, etc.*
- **Power consumption**
 - *average, peak and total*
- **Optimizations**
 - *transferring from one dimension to another*
 - *design quality is measured by combined parameters, e.g., energy consumption per input sample*



HDL – designing Systems-on-Chip (SoC) & Networks-on-Chip (NoC)

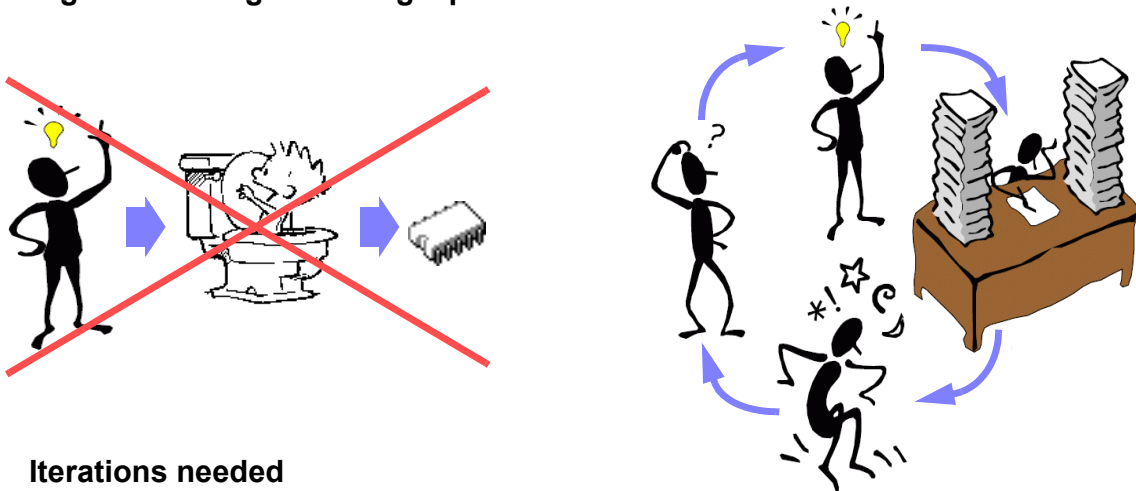


- Fully automated flow from specification to implementation?
- analysis, modeling, iterations etc. needed...



MYTH #1

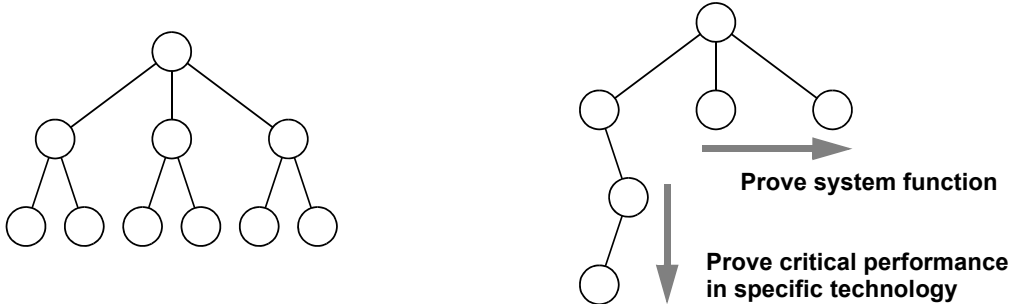
- High level design is a single pass



- Iterations needed
 - Functionality
 - Design goals

MYTH #2

- **Top down design, in its purest form, works**



- **The pure breadth-first approach never actually works in practice**
 - **Bottom-up technology information must be considered early and often**
 - **Go depth-first for critical parts**
 - **Mix breadth-first with depth-first**

MYTH #3

- **You don't need to understand digital design anymore**
- **One must know hardware to get a good hardware**
- **Hope**
 - **Intimate knowledge of hardware is not necessary to design digital systems**
- **Fear**
 - **Using HDL based design methodology will turn them into software hackers**
- **Reality**
 - **High performance designs require a good deal of understanding about hardware**
 - **Designers must seed the synthesis tools with good starting points**
 - **Understanding the synthesis process is necessary to get good quality designs**



MYTH #4

- Designer's job is just the functional specification now

- **Specification = Functionality +
Design goals +
Operating conditions**

- **Schematic capture**
 - Design goals and operating conditions were implicit (in designer's mind)
 - Implementation was chosen (modified) to meet goals and conditions

- **HDL**
 - Design goals (area, speed, power, etc.) are explicitly specified
 - Operating conditions (variations, loads, drives) are also explicitly specified



MYTH #5

- Behavioral level is better than RTL

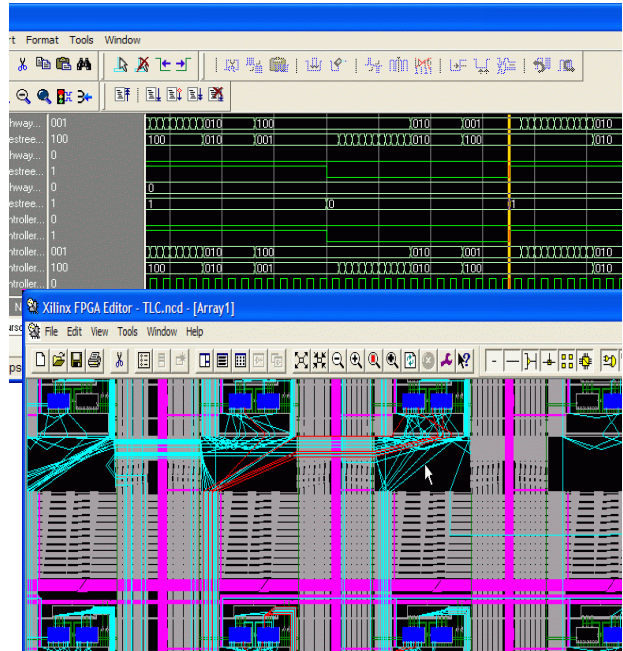
- Behavioral (a.k.a. algorithmic, high) level synthesis is not as mature as RTL (register-transfer level)
- If your specification includes enough timing information use RTL synthesis
- Behavioral constructs like *while*, *if-then-else* does not necessarily mean behavioral specification
 - ... and/or can be misinterpreted

Design process today

- Hardware Description Language

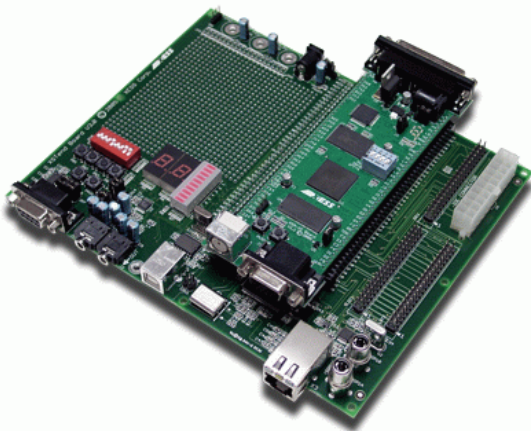
```

--
-- Highway is green, sidestreet is red.
--
if sidestreet_car = NoCar then
  wait until sidestreet_car = Car;
end if;
-- Waiting for no more than 25 seconds ...
if highway_car = Car then
  wait until highway_car = NoCar for 25 sec;
end if;
-- ... and changing lights
highway_light <= GreenBlink;
wait for 3 sec;
highway_light <= Yellow;
sidestreet_light <= Yellow;
wait for 2 sec;
highway_light <= Red;
sidestreet_light <= Green;
  
```

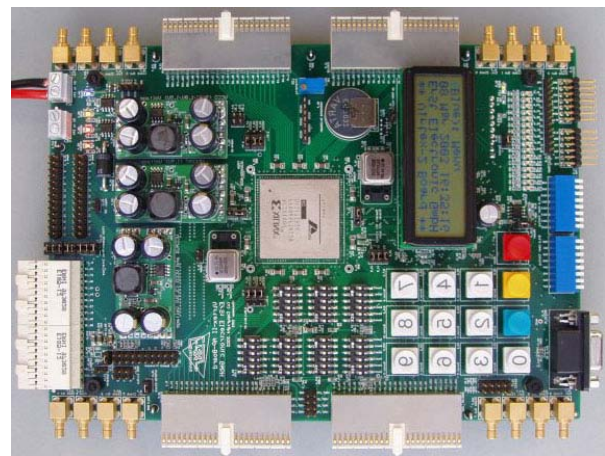


Prototyping

- Possibility to check how a system works at conditions very close to the operating environment without the need to create expensive chips

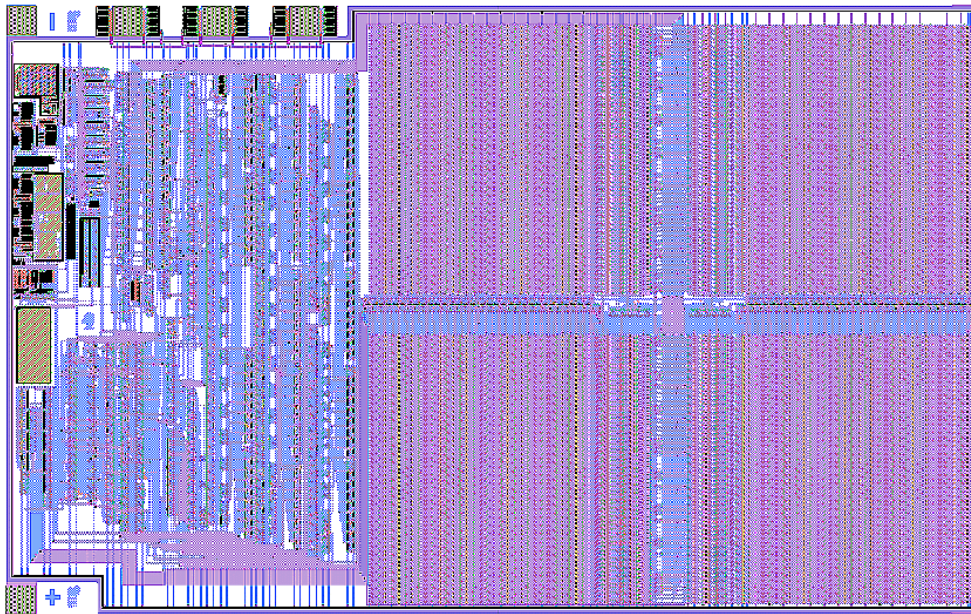


XESS Corp., www.xess.com, \$400
[Xilinx Inc., FPGA XC3S1000]



ErST Electronics, www.erst.ch, 2340€
[Xilinx Inc., FPGA X2V2000]

Chip - the final result



Reality

- **Found On First Spin ICs/ASICs**
 - Functional Logic Error - 43%
 - Analog Tuning Issue - 20%
 - Signal Integrity Issue - 17%
 - Clock Scheme Error - 14%
 - Reliability Issue - 12%
 - Mixed Signal Problem - 11%
 - Uses Too Much Power - 11%
 - Has Path(s) Too Slow - 10%
 - Has Path(s) Too Fast - 10%
 - IR Drop Issues - 7%
 - Firmware Error - 4%
 - Other Problem - 3%
- **Overall 61% of New ICs/ASICs Require At Least One Re-Spin.**
 - Aart de Geus, Chairman & CEO of Synopsys, Boston SNUG keynote address, 9.09.2003



Trends

	2000	2010	2020
memory size	2 Gbit	256 Gbit	1024 Gbit
transistors per cm ²	8·10 ⁶	160·10 ⁶	480·10 ⁶
internal clock frequency	1.5 GHz	10 GHz	40 GHz
external / bus clock frequency	0.5 GHz	1.5 GHz	2.5 GHz
pin count	2000	6000	10000
chip area	800 mm ²	1300 mm ²	1800 mm ²
wire width	140 nm	40 nm	10 nm
supply voltage	1.5 V	0.8 V	0.5 V
power consumption	100 W	170 W	300 W
power consumption (batteries)	0.5 W	1.5 W	2.5 W

NB! These are rough estimates only!



Problems

physical level

quantum effects

noise

logic level

crosstalk

speed of light

system level

of transistors



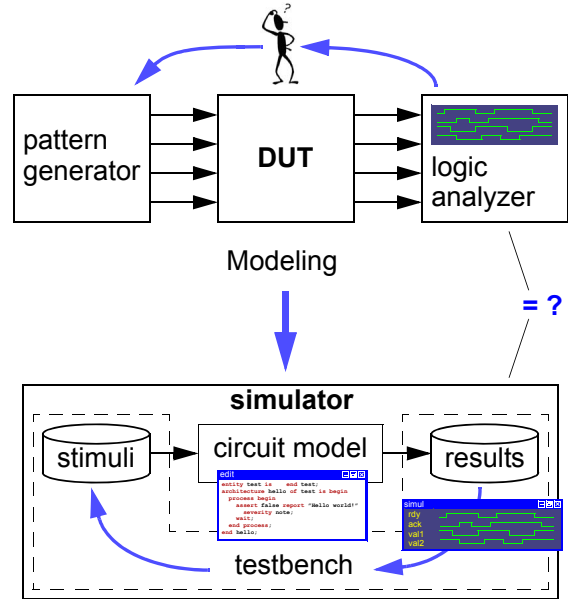
10 mm → (10⁸ m/s) →
 10⁻¹⁰ s → (10%) →
 1 GHz !?

- **GALS – globally asynchronous locally synchronous**
- **mixed signal – digital and analog circuits on the same chip**
- **Modelling is getting more and more important...**



Simulation

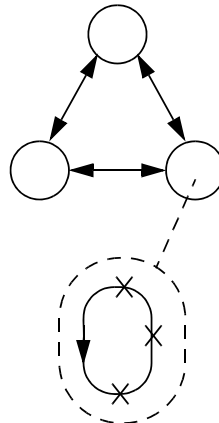
- Simulation = modeling + analysis
- Logic level simulation
- RT-level simulation
- Functional level simulation
 - Behavioral level simulation
- System level simulation
- Test environment == stimuli generator + DUT + results analyzer
- NB! Detailed simulation is slow!



Use of HDL → Simulation

- Simulation = modelling + analysis
 - Logic / register-transfer / functional (behavioral) / system level simulation

concurrent / parallel modules
 connected via signal / channels
 sequential vs. concurrent execution?
 execution order?!
 current / new values to avoid non-determinism
 event queue history+future



module / unit / process
 continuous execution is slow
 only when needed?
 time / event triggered
 different simulation engines



Simulators

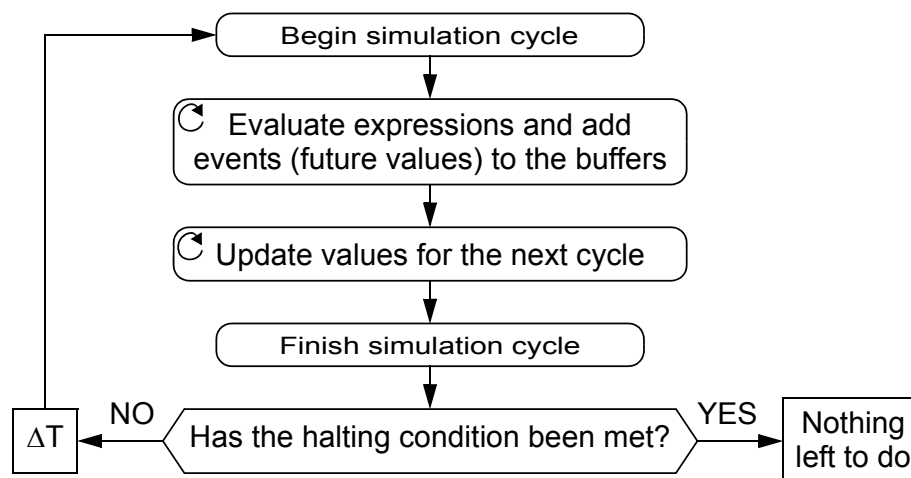
- **Time-driven:**
all components of the digital logic system are evaluated at every time step
- **Event-driven:**
system input events are kept in a time-ordered event queue

Simulation delay models

- Unit-delay (RTL simulator)
- Zero-delay
- *delta*-delay (VHDL) – δ -delay, Δ -delay



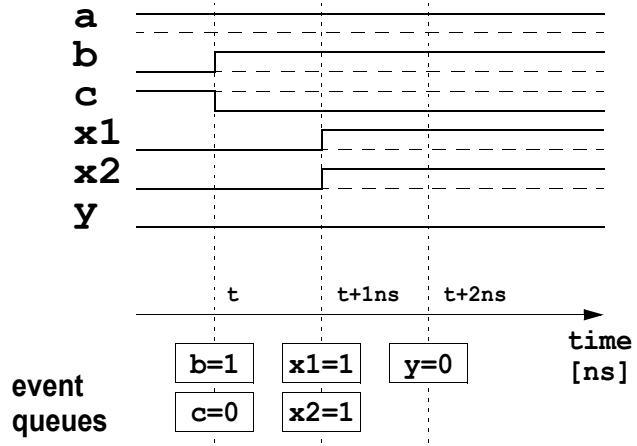
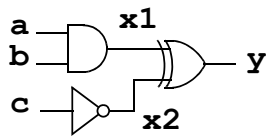
Unit-delay simulation model



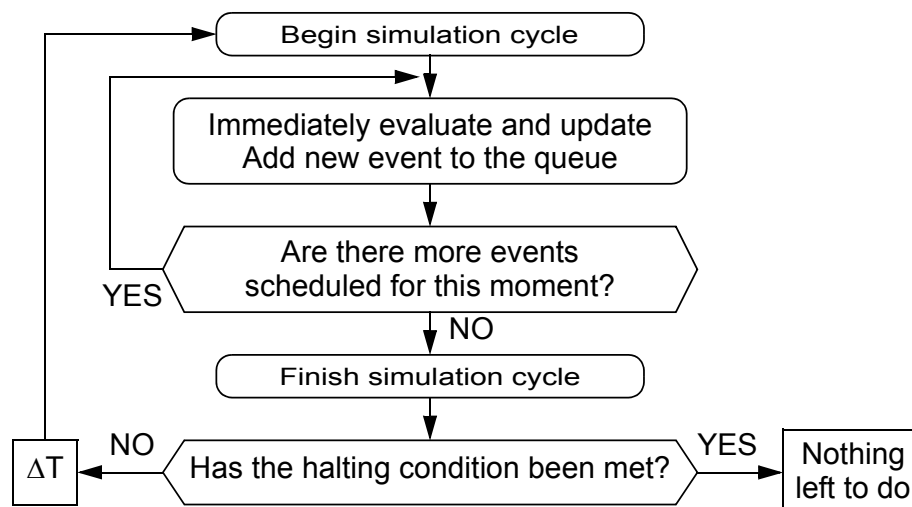


Unit-delay simulation model (example)

```
x1 <= a and b;
x2 <= not c;
y <= x1 xor x2;
```



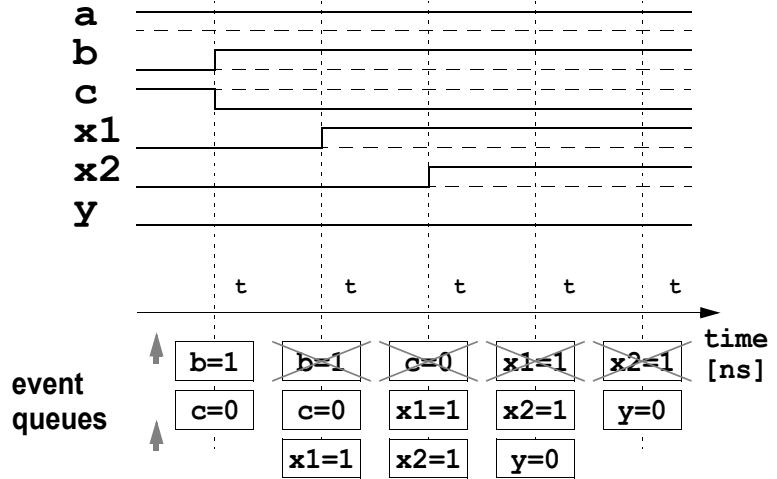
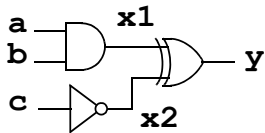
Zero-delay simulation model (Verilog)





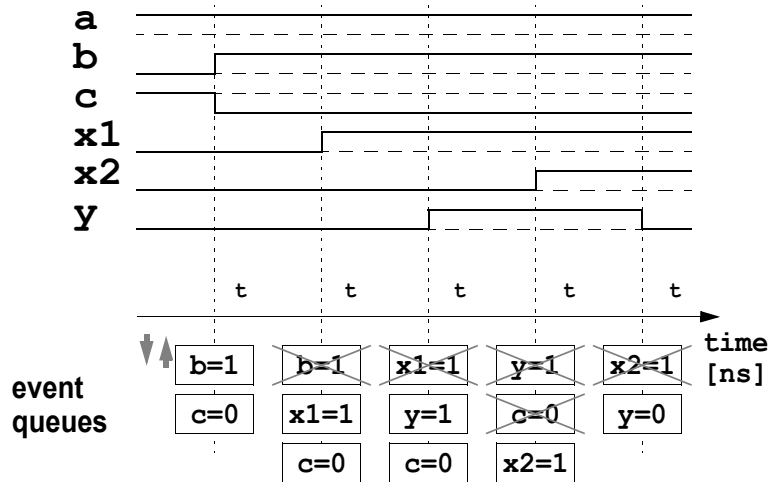
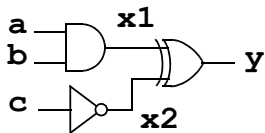
Zero-delay simulation model (example #1)

```
x1 <= a and b;
x2 <= not c;
y <= x1 xor x2;
```



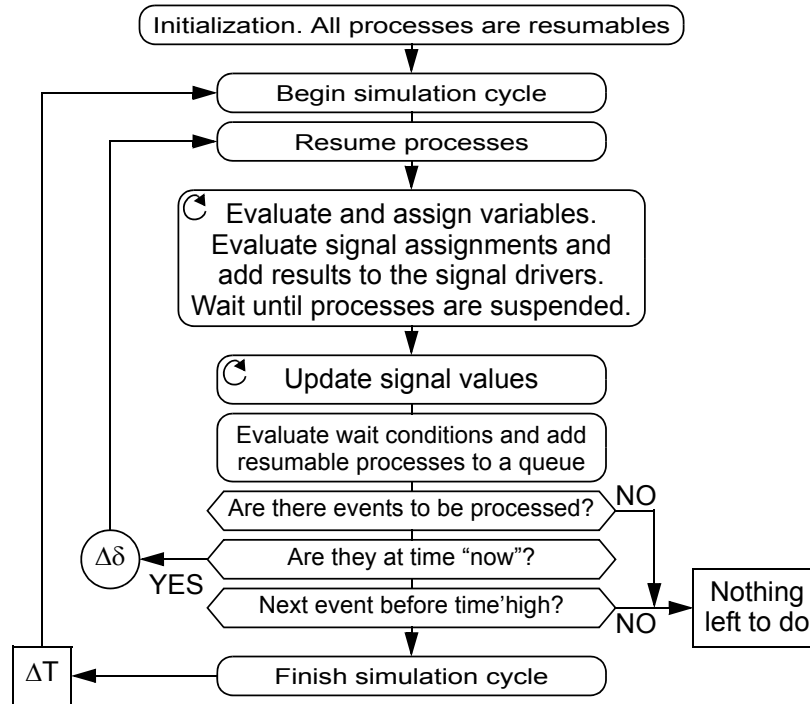
Zero-delay simulation model (example #2)

```
x1 <= a and b;
x2 <= not c;
y <= x1 xor x2;
```





Delta-delay (VHDL) simulation model



Delta-delay (VHDL) simulation model (example)

```
x1 <= a and b;
x2 <= not c;
y <= x1 xor x2;
```

